

May 23, 2001

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ney Docket No.: 8728-479 (YOR9-2001-0003US1)

1. Name of conveying party(ies):

15/23/01
Takahisa Amemiya
Toshiaki Arai
Evan George Colgan
Yoshitami Sakaguchi
Kazumi Sakai
Kai R. Schleupen

Additional name(s) of conveying party(ies) attached?

[] yes

[X] no

2. Name and address of receiving party(ies):

Name:

International Business Machines Corporation

Internal Address:

Street Address:

City:

Armonk

Country/State/Zip:

New York, 10504

Additional names and addresses attached? [] yes [X] no

3. Nature of Conveyance

[X] Assignment

[] Merger

[] Security Agreement

[] Change of Name

[] Other

Execution Date: 4/26/01; 5/7/01; 4/18/01; 4/26/01; 5/11/01; and
4/18/01, respectively

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is 4/26/01; 5/7/01; 4/18/01;
4/26/01; 5/11/01; and 4/18/01, respectively;

A. Patent Application No.(s)

N/A

B. Patent No.(s):

N/A

Additional numbers attached? [] Yes [X] No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Frank Chau, Esq.

Internal Address: F. Chau & Associates, LLP

Street Address: 1900 Hempstead Turnpike, Suite 501

City: East Meadow State: NY ZIP: 11554

6. Total number of applications and patents involved:

[1]

7. Total fee (37 C.F.R. 3.41) \$ 40.00

[] Enclosed

[X] Authorized to be charged to deposit account

8. Deposit account number: 50-0510/IBM (Yorktown Heights)
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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

James J. Bitetto, Esq.

Name of Person Signing
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May 23, 2001

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Assignment

Whereas, we

Inventor
and City

(1) **Takahisa Amemiya**
County of

of **Japan**
and State of

and (2) **Toshiaki Arai**
County of

of **Japan**
and State of

and (3) **Evan George Colgan**
County of **Rockland County**

of **Chestnut Ridge**
and State of **New York**

and (4) **Yoshitami Sakaguchi**
County of

of **Japan**
and State of

and (5) **Kazumi Sakai**
County of

of **Japan**
and State of

and (6) **Kai R. Schleupen**
County of **Westchester County**

of **Yorktown Heights**
and State of **New York**

have invented certain improvements in

TITLE

**LOW RESISTANCE WIRING IN THE PERIPHERY REGION OF DISPLAYS AND
METHOD FOR FABRICATION**

and executed, respectively, a United States patent application therefor on

DATES THAT (1) 4/26/ 2001 and (2) 5/7/ 2001 and (3) 4/18/ 2001
INVENTORS (4) 4/26/ 2001 and (5) 5/11/ 2001 and (6) 4/18/ 2001.
SIGNED THE
DECLARATION

Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM) desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we the above named, hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

Signed and sealed
CITY (1) at Yamato
DATE on 4/26/ 2001, Takahisa Amemiya INVENTOR
FIRST NAME MIDDLE INITIAL LAST NAME

Signed and sealed
CITY and (2) at Yamato
DATE on 5/7/ 2001, Toshiaki Arai INVENTOR
FIRST NAME MIDDLE INITIAL LAST NAME

Signed and sealed
CITY and (3) at Yorktown Heights
DATE on 4/18/ 2001, Evan George Colgan INVENTOR
FIRST NAME MIDDLE INITIAL LAST NAME

Signed and sealed
CITY and (4) at Yamato
DATE on 5/11/ 2001, Yoshitami Sakaguchi INVENTOR
FIRST NAME MIDDLE INITIAL LAST NAME

RECORDED: 05/23/2001

PATENT
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